

# **AUTOMATED POLISHING**

STEP 05: POLISH



MF40 Pharma



MF80 Pharma

### FEATURES & BENEFITS

STEP 05: POLISH

#### **AUTOMATED POLISHING MACHINES**

Polish dull and discoloured punches to a micro-fine, high quality finish using a drag finishing process.

#### **KEY FEATURES:**

- Stainless or Aluminium cabinet with door and perspex windows
- · Tool holding fixtures attached to drive unit
- Automatic drag finishing process
- · Variable speed drive
- Timer and safety interlock
- · All electrics are single phase
- · CE marked
- · Compatible with various media types
- · Now available with acetal, food grade punch holders

#### **CORE BENEFITS:**

- · Polish dull and discoloured punches to a micro-fine, high quality finish
- · Can polish coated punches
- · Reduce health and safety risks
- · Eliminate risk of overpolishing
- · Allow smoother operation and improved efficiency within the tablet press
- · Enable higher press speeds and increased tablet productivity
- · Can help overcome common tooling problems such as sticking and corrosion
- · Easy to use with minimum training required
- · Consistent results every time















## PRODUCT SPECIFICATION

STEP 05: POLISH

TECHNICAL SPECIFICATIONS						
PART NUMBER	MACHINE	WIDTH(MM)	DEPTH(MM)	HEIGHT(MM)	WEIGHT(KG)	POWER (KVA/V)
HEPO-MF040	Microfine Polishing Machine - MF40 Pharma	1124	851	1972	350	1,2/230
HEPO-MF080	Microfine Polishing Machine - MF80 Pharma	1330	1090	2260	500	2,0/230

EXTRAS		
PART NUMBER	DESCRIPTION	QUANTITY
HEPO-IQOQ	IQ/OQ Documentation for MF Polisher	1
HEPO-SSMIXPAD	Stainless Steel Mixing Paddle for Polishing Paste	1
HEPO-COO04	Water Cooling System for MF40 Pharma	1
HEPO-COO05	Water Cooling System for MF80 Pharma	1

MF POLISHER PUNCH HOLDERS AND CAPACITY							
TYPE OF HOLDER	ACETAL			STEEL			
DESCRIPTION	B-TYPE	D-TYPE	441	FS-12	IMA	20/28	25/32
MF40	3 X 17 HOLES (51 PUNCHES) K-HEPO-COM22	3 X 12 HOLES (36 PUNCHES) K-HEPO-COM23	3 X 10 HOLES (30 PUNCHES) K-HEPO-COM29	3 X 22 HOLES (66 PUNCHES) K-HEPO-COM26	3 X 10 HOLES (30 PUNCHES) K-HEPO-COM01/I	6 X 9 HOLES (U&L) (27 PUNCHES) K-HEPO-COM01/K	6 X 9 HOLES (U&L) (27 PUNCHES) K-HEPO- COM03/K
MF80	5 X 17 HOLES (85 PUNCHES) K-HEPO-COM30	5 X 12 HOLES (60 PUNCHES) K-HEPO-COM31	5 X 10 HOLES (50 PUNCHES) K-HEPO-COM37	5 X 22 HOLES (110 PUNCHES) K-HEPO-COM35	5 X 10 HOLES (50 PUNCHES) K-HEPO-COM02/I	10 X 9 HOLES (U&L) (45 PUNCHES) K-HEPO- COM02/K	10 X 9 HOLES (U&L) (45 PUNCHES) K-HEPO- COM04/K

MF POLISHER DIE HOLDERS AND CAPACITY					
DESCRIPTION	D-TYPE	В-ТҮРЕ	ВВ-ТҮРЕ	BBB-TYPE	BBS-TYPE
MF 35/40&70/80	10 X D DIES K-HEPO-DIE02	12 X B DIES K-HEPO-DIE03	12 X BB DIES K-HEPO-DIE04	16 X BBB DIES K-HEPO-DIE08	16 X BBS DIES K-HEPO-DIE07
MF12	4 x D DIES K-HEPO-DIE09	6 X B DIES K-HEPO-DIE05	6 X BB DIES K-HEPO-DIE06		

### MF POLISHING // THE KEY FACTS:

01. Polish dull and discoloured punches to a micro-fine high quality finish using a drag finishing process // 02. The entire punch is automatically rotated through media and polishing paste // 03. Automated process saves valuable time in the tool room and ensures consistent results each and every time // 04. Means smoother operation and improved efficiency in the tablet press // 05. Can help overcome common tooling problems such as sticking and corrosion

### MF POLISHER ACCESSORIES

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POLISHING GRANULE					
PART NUMBER	NUMBER NOTES				
HEPO-PLA01A	DFPAO/400 Plastic - Best polishing capabilities. Chiller unit recommended	25kg			
HEPO-WAL01	H1/500 Walnut - Good polishing capabilities, however is not suitable for 'nut free' environments	25kg			
HEPO-MAZ03	M1/03 Maize - Offered as 'nut free' alternative to the walnut media	25kg			
HEPO-WAL02	Irradiated H1/500 Walnut - Goes through a radiation process (dosage of 10-30 kilogray) to kill bacteria	25kg			
HEPO-MAZ02	Irradiated M1/03 Maize - Goes through a radiation process (dosage of 10-30 kilogray) to kill bacteria	25kg			
POLISHING PASTE					
HEPO-PLA05	P16 - For Plastic - Used to charge the media prior to use and re- charge the media after every 10 polishing hours	1kg			
HEPO-PLA04	P16 - For Plastic - Used to charge the media prior to use and re- charge the media after every 10 polishing hours	7.5kg			
HEPO-PAS03	PI- For Walnut & Maize - Used to re-charge the media after every 10 polishing hours	lkg			
HEPO-PAS02/2	PI- For Walnut & Maize - Used to re-charge the media after every 10 polishing hours	7.5kg			

#### **CONSUMABLE POLISHING MEDIA AND PASTE**

PLEASE NOTE: Media should be replaced after every 100 hours use and paste after every 10













